July 26, 2007

FN7193.3

Dual 300MHz Current Feedback Amplifier with Enable

The EL5293 and EL5293A represent dual current feedback amplifiers with a bandwidth of 300MHz. This makes these amplifiers ideal for today's high speed video and monitor applications.

With a supply current of just 4mA per amplifier and the ability to run from a single supply voltage from 5V to 10V, these amplifiers are also ideal for hand held, portable or battery powered equipment.

The EL5293A also incorporates an enable and disable function to reduce the supply current to $100\mu A$ typical per amplifier. Allowing the \overline{CE} pin to float or applying a low logic level will enable the amplifier.

The EL5293 is offered in the industry-standard 8 Ld SOIC package and the space-saving 8 Ld MSOP package. The EL5293A is available in a 10 Ld MSOP package and all operate over the industrial temperature range of -40°C to +85°C.

Ordering Information

•			
PART NUMBER	PART MARKING	PACKAGE	PKG. DWG. #
EL5293CS	5293CS	8 Ld SOIC	MDP0027
EL5293CS-T7*	5293CS	8 Ld SOIC	MDP0027
EL5293CS-T13*	5293CS	8 Ld SOIC	MDP0027
EL5293CSZ (Note)	5293CSZ	8 Ld SOIC (Pb-free)	MDP0027
EL5293CSZ-T7* (Note)	5293CSZ	8 Ld SOIC (Pb-free)	MDP0027
EL5293CSZ-T13* (Note)	5293CSZ	8 Ld SOIC (Pb-free)	MDP0027
EL5293CY	V	8 Ld MSOP	MDP0043
EL5293CY-T7*	V	8 Ld MSOP	MDP0043
EL5293CY-T13*	V	8 Ld MSOP	MDP0043
EL5293ACY	Υ	10 Ld MSOP	MDP0043
EL5293ACY-T7*	Υ	10 Ld MSOP	MDP0043
EL5293ACY-T13*	Υ	10 Ld MSOP	MDP0043

^{*}Please refer to TB347 for details on reel specifications.

NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

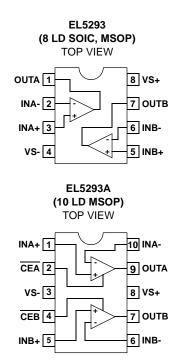
Features

- 300MHz -3dB bandwidth
- 4mA supply current (per amplifier)
- · Single and dual supply operation, from 5V to 10V
- Fast enable/disable (EL5293A only)
- Single (EL5193) and triple (EL5393) available
- High speed, 1GHz product available (EL5191)
- High speed, 6mA, 600MHz product available (EL5192, EL5292, and EL5392)
- Pb-free plus anneal available (RoHS compliant)

Applications

- Battery-powered equipment
- · Hand-held, portable devices
- · Video amplifiers
- · Cable drivers
- RGB amplifiers
- Test equipment
- Instrumentation
- · Current to voltage converters

Pinouts



EL5293, EL5293A

Absolute Maximum Ratings $(T_A = +25^{\circ}C)$

Thermal Information

Storage Temperature	65°C to +150°C
Ambient Operating Temperature	40°C to +85°C
Operating Junction Temperature	+125°C
Power Dissipation	See Curves
Pb-free reflow profile	see link below
http://www.intersil.com/pbfree/Pb-FreeReflow	.asp

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

Electrical Specifications

 $V_S+=+5V$, $V_{S^-}=-5V$, $R_F=750\Omega$ for $A_V=1$, $R_F=375\Omega$ for $A_V=2$, $R_L=150\Omega$, $T_A=+25^{\circ}C$ unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 2)	TYP	MAX (Note 2)	UNIT
AC PERFORM	ANCE		'		'	l
BW	-3dB Bandwidth	A _V = +1		300		MHz
		A _V = +2		200		MHz
BW1	0.1dB Bandwidth			20		MHz
SR	Slew Rate	$V_O = -2.5V$ to +2.5V, $A_V = +2$	1900	2200		V/µs
ts	0.1% Settling Time	$V_{OUT} = -2.5V$ to +2.5V, $A_V = -1$		12		ns
CS	Channel Separation	f = 5MHz		60		dB
e _N	Input Voltage Noise			4.4		nV/√Hz
i _N -	IN- Input Current Noise			17		pA/√Hz
i _N +	IN+ Input Current Noise			50		pA/√Hz
dG	Differential Gain Error (Note 1)	A _V = +2		0.03		%
dP	Differential Phase Error (Note 1)	A _V = +2		0.04		0
DC PERFORM	ANCE		'		-	+
Vos	Offset Voltage		-10	1	10	mV
T _C V _{OS}	Input Offset Voltage Temperature Coefficient	Measured from T _{MIN} to T _{MAX}		5		μV/°C
R _{OL}	Transimpediance		300	600		kΩ
INPUT CHARA	ACTERISTICS					
CMIR	Common Mode Input Range		±3	±3.3		V
CMRR	Common Mode Rejection Ratio		42	50		dB
+I _{IN}	+ Input Current		-60	1	80	μA
-I _{IN}	- Input Current		-35	1	35	μA
R _{IN}	Input Resistance			45		kΩ
C _{IN}	Input Capacitance			0.5		pF
OUTPUT CHA	RACTERISTICS					
Vo	Output Voltage Swing	$R_L = 150\Omega$ to GND	±3.4	±3.7		V
		$R_L = 1k\Omega$ to GND	±3.8	±4.0		V
I _{OUT}	Output Current	$R_L = 10\Omega$ to GND	95	120		mA
SUPPLY						
I _{SON}	Supply Current - Enabled (per amplifier)	No load, V _{IN} = 0V	3	4	5	mA
I _{SOFF}	Supply Current - Disabled (per amplifier)	No load, V _{IN} = 0V		100	150	μA
PSRR	Power Supply Rejection Ratio	DC, $V_S = \pm 4.75V$ to $\pm 5.25V$	55	75		dB

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EL5293, EL5293A

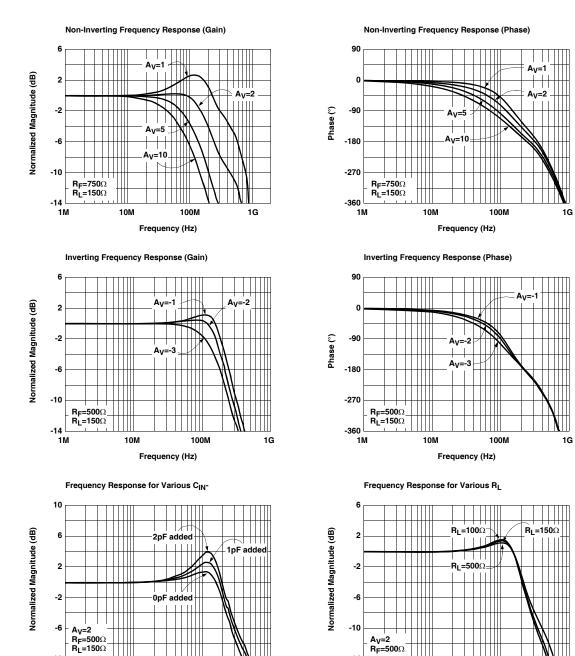
Electrical Specifications V_S + = +5V, V_S - = -5V, R_F = 750 Ω for A_V = 1, R_F = 375 Ω for A_V = 2, R_L = 150 Ω , T_A = +25°C unless otherwise specified. **(Continued)**

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 2)	TYP	MAX (Note 2)	UNIT	
-IPSR	- Input Current Power Supply Rejection	DC, $V_S = \pm 4.75V$ to $\pm 5.25V$	-2		2	μA/V	
ENABLE (EL5	ENABLE (EL5293A ONLY)						
t _{EN}	Enable Time			40		ns	
t _{DIS}	Disable Time			600		ns	
I _{IHCE}	CE Pin Input High Current	CE = V _S +		0.8	6	μA	
I _{ILCE}	CE Pin Input Low Current	CE = V _S -		0	-0.1	μA	
V _{IHCE}	CE Input High Voltage for Power-down		V _S + - 1			V	
VILCE	CE Input Low Voltage for Power-down				V _S + - 3	V	

NOTE:

- 1. Standard NTSC test, AC signal amplitude = $286mV_{P-P}$, f = 3.58MHz
- 2. Parts are 100% tested at +25°C. Over-temperature limits established by characterization and are not production tested.

Typical Performance Curves



-14 1M

10M

100M

Frequency (Hz)

1G

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100M

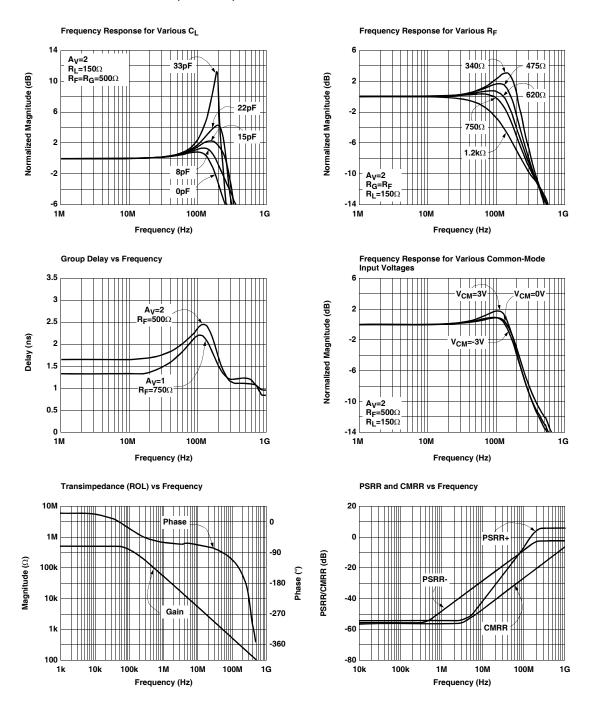
Frequency (Hz)

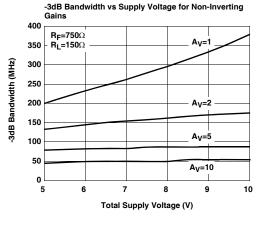
1G

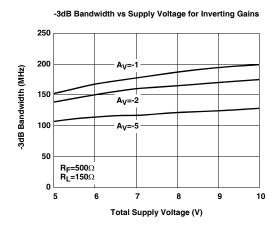
10M

-10 1M

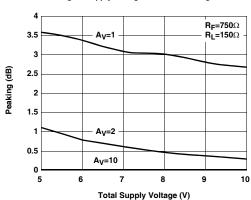
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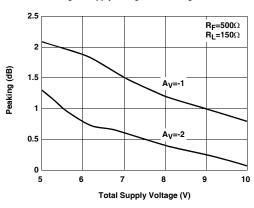




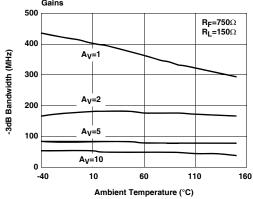




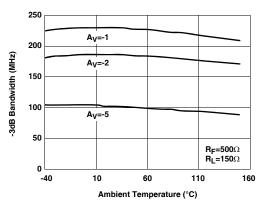


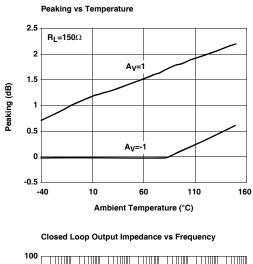


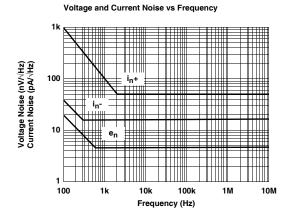
-3dB Bandwidth vs Temperature for Non-Inverting Gains

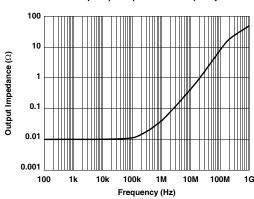


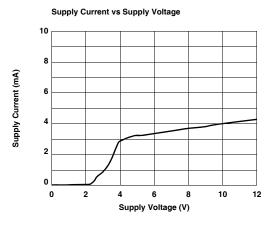
-3dB Bandwidth vs Temperature for Inverting Gains

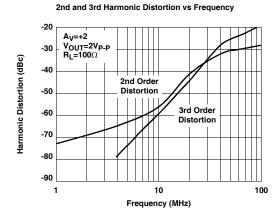


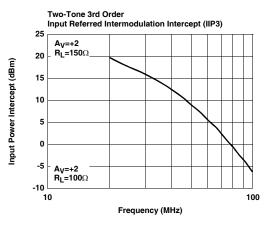




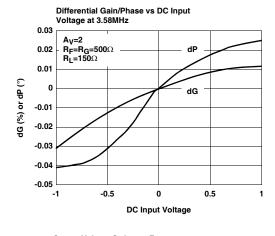


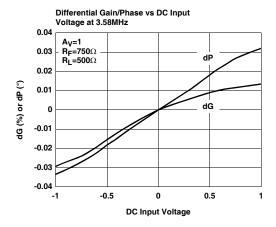


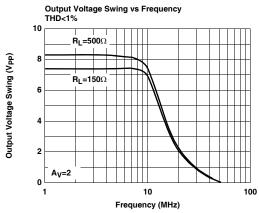


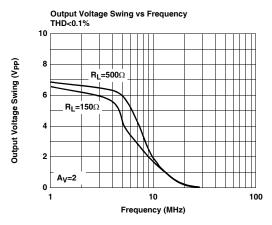


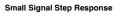
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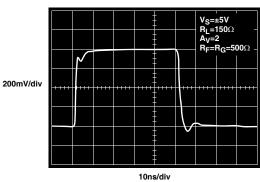




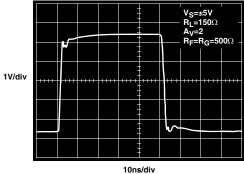


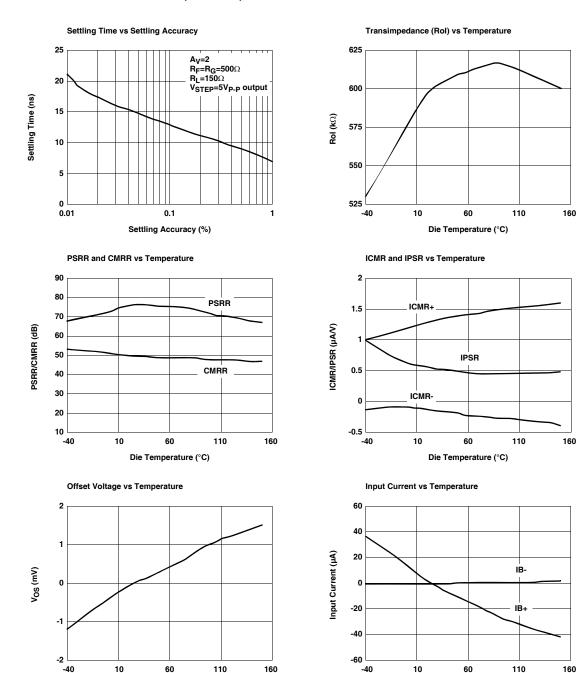






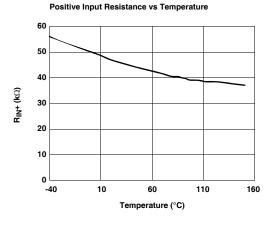


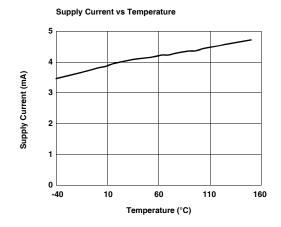


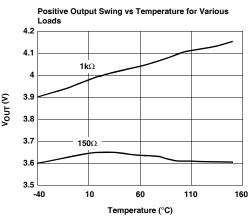


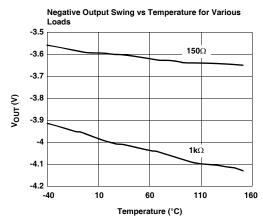
Die Temperature (°C)

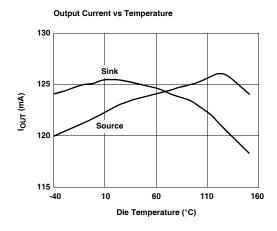
Temperature (°C)

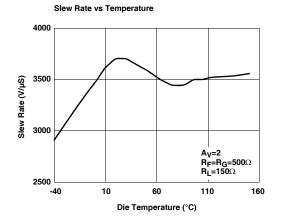


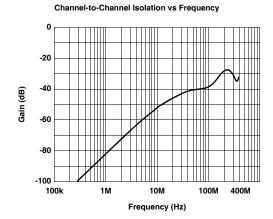


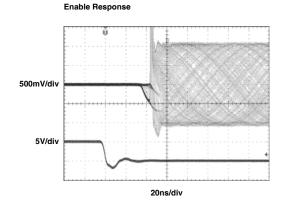




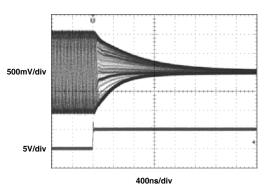


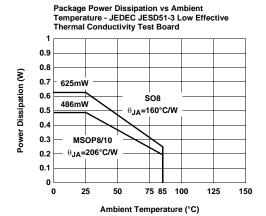




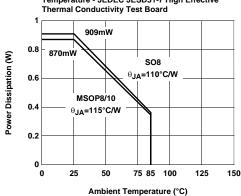








Package Power Dissipation vs Ambient Temperature - JEDEC JESD51-7 High Effective Thermal Conductivity Test Board



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Pin Descriptions

	-			
8 LD SOIC, MSOP	10 LD MSOP	PIN NAME	FUNCTION	EQUIVALENT CIRCUIT
1	O	OUTA	Output, channel A	V _S + OUT Circuit 1
2	10	INA-	Inverting input, channel A	V _S +
3	1	INA+	Non-inverting input, channel A	(see circuit 2)
	2	CEA	Chip enable, channel A	Circuit 3
4	3	VS-	Negative supply	
	4	CEB	Chip enable, channel B	(see circuit 3)
5	5	INB+	Non-inverting input, channel B	(see circuit 2)
6	6	INB-	Inverting input, channel B	(see circuit 2)
7	7	OUTB	Output, channel B	(see circuit 1)
8	8	VS+	Positive supply	

Applications Information

Product Description

The EL5293 is a current-feedback operational amplifier that offers a wide -3dB bandwidth of 300MHz and a low supply current of 4mA per amplifier. The EL5293 works with supply voltages ranging from a single 5V to 10V and they are also capable of swinging to within 1V of either supply on the output. Because of their current-feedback topology, the EL5293 does not have the normal gain-bandwidth product associated with voltage-feedback operational amplifiers. Instead, its -3dB bandwidth to remain relatively constant as closed-loop gain is increased. This combination of high bandwidth and low power, together with aggressive pricing make the EL5293 the ideal choice for many low-power/high-bandwidth applications such as portable, handheld, or battery-powered equipment.

For varying bandwidth needs, consider the EL5191 with 1GHz on a 9mA supply current or the EL5192 with 600MHz on a 6mA supply current. Versions include single, dual, and triple amp packages with 5 Ld SOT23, 16 Ld QSOP, and 8 Ld or 16 Ld SOIC outlines.

Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, good printed circuit board layout is necessary for optimum performance. Low impedance ground plane construction is essential. Surface mount components are recommended, but if leaded components are used, lead lengths should be as short as possible. The power supply pins must be well bypassed to reduce the risk of oscillation. The combination of a $4.7\mu F$ tantalum capacitor in parallel with a $0.01\mu F$ capacitor has been shown to work well when placed at each supply pin.

For good AC performance, parasitic capacitance should be kept to a minimum, especially at the inverting input. (See the Capacitance at the Inverting Input section) Even when ground plane construction is used, it should be removed from the area near the inverting input to minimize any stray capacitance at that node. Carbon or Metal-Film resistors are acceptable with the Metal-Film resistors giving slightly less peaking and bandwidth because of additional series inductance. Use of sockets, particularly for the SOIC package, should be avoided if possible. Sockets add parasitic inductance and capacitance which will result in additional peaking and overshoot.

Disable/Power-Down

The EL5293A amplifier can be disabled placing its output in a high impedance state. When disabled, the amplifier supply current is reduced to < 300 μ A. The EL5293A is disabled when its \overline{CE} pin is pulled up to within 1V of the positive supply. Similarly, the amplifier is enabled by floating or pulling its \overline{CE} pin to at least 3V below the positive supply. For ± 5 V supply, this means that an EL5293A amplifier will be enabled when \overline{CE} is 2V or less, and disabled when \overline{CE} is above 4V. Although the logic levels are not standard TTL, this choice of logic voltages allows the EL5293A to be enabled by tying \overline{CE} to ground, even in 5V single supply applications. The \overline{CE} pin can be driven from CMOS outputs.

Capacitance at the Inverting Input

Any manufacturer's high-speed voltage- or current-feedback amplifier can be affected by stray capacitance at the inverting input. For inverting gains, this parasitic capacitance has little effect because the inverting input is a virtual ground, but for non-inverting gains, this capacitance (in conjunction with the feedback and gain resistors) creates a pole in the feedback path of the amplifier. This pole, if low enough in frequency, has the same destabilizing effect as a zero in the forward open-loop response. The use of large-value feedback and gain resistors exacerbates the problem by further lowering the pole frequency (increasing the possibility of oscillation).

The EL5293 has been optimized with a 475 Ω feedback resistor. With the high bandwidth of these amplifiers, these resistor values might cause stability problems when combined with parasitic capacitance, thus ground plane is not recommended around the inverting input pin of the amplifier.

Feedback Resistor Values

The EL5293 has been designed and specified at a gain of +2 with R_F approximately 500Ω . This value of feedback resistor gives 200MHz of -3dB bandwidth at A_V = 2 with 2dB of peaking. With A_V = -2, an R_F of approximately 500Ω gives 175MHz of bandwidth with 0.2dB of peaking. Since the EL5293 is a current-feedback amplifier, it is also possible to change the value of R_F to get more bandwidth. As seen in the curve of Frequency Response for Various R_F and R_G,

bandwidth and peaking can be easily modified by varying the value of the feedback resistor.

Because the EL5293 is a current-feedback amplifier, its gain-bandwidth product is not a constant for different closed-loop gains. This feature actually allows the EL5293 to maintain about the same -3dB bandwidth. As gain is increased, bandwidth decreases slightly while stability increases. Since the loop stability is improving with higher closed-loop gains, it becomes possible to reduce the value of $R_{\rm F}$ below the specified 475Ω and still retain stability, resulting in only a slight loss of bandwidth with increased closed-loop gain.

Supply Voltage Range and Single-Supply Operation

The EL5293 has been designed to operate with supply voltages having a span of greater than 5V and less than 10V. In practical terms, this means that the EL5293 will operate on dual supplies ranging from ±2.5V to ±5V. With single-supply, the EL5293 will operate from 5V to 10V.

As supply voltages continue to decrease, it becomes necessary to provide input and output voltage ranges that can get as close as possible to the supply voltages. The EL5293 has an input range which extends to within 2V of either supply. So, for example, on +5V supplies, the EL5293 has an input range which spans ±3V. The output range of the EL5293 is also quite large, extending to within 1V of the supply rail. On a ±5V supply, the output is therefore capable of swinging from -4V to +4V. Single-supply output range is larger because of the increased negative swing due to the external pull-down resistor to ground.

Video Performance

For good video performance, an amplifier is required to maintain the same output impedance and the same frequency response as DC levels are changed at the output. This is especially difficult when driving a standard video load of 150 Ω , because of the change in output current with DC level. Previously, good differential gain could only be achieved by running high idle currents through the output transistors (to reduce variations in output impedance.) These currents were typically comparable to the entire 4mA supply current of each EL5293 amplifier. Special circuitry has been incorporated in the EL5293 to reduce the variation of output impedance with current output. This results in dG and dP specifications of 0.03% and 0.04°, while driving 150 Ω at a gain of 2.

Video performance has also been measured with a 500Ω load at a gain of +1. Under these conditions, the EL5293 has dG and dP specifications of 0.03% and 0.04°.

Output Drive Capability

In spite of its low 4mA of supply current, the EL5293 is capable of providing a minimum of ±95mA of output current. With a minimum of ±95mA of output drive, the EL5293 is

capable of driving 50Ω loads to both rails, making it an excellent choice for driving isolation transformers in telecommunications applications.

Driving Cables and Capacitive Loads

When used as a cable driver, double termination is always recommended for reflection-free performance. For those applications, the back-termination series resistor will decouple the EL5293 from the cable and allow extensive capacitive drive. However, other applications may have high capacitive loads without a back-termination resistor. In these applications, a small series resistor (usually between 5Ω and 50Ω) can be placed in series with the output to eliminate most peaking. The gain resistor (R_G) can then be chosen to make up for any gain loss which may be created by this additional resistor at the output. In many cases it is also possible to simply increase the value of the feedback resistor (R_F) to reduce the peaking.

Current Limiting

The EL5293 has no internal current-limiting circuitry. If the output is shorted, it is possible to exceed the Absolute Maximum Rating for output current or power dissipation, potentially resulting in the destruction of the device.

Power Dissipation

With the high output drive capability of the EL5293, it is possible to exceed the +125°C Absolute Maximum junction temperature under certain very high load current conditions. Generally speaking when R_I falls below about 25 Ω , it is

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important to calculate the maximum junction temperature (T_{JMAX}) for the application to determine if power supply voltages, load conditions, or package type need to be modified for the EL5293 to remain in the safe operating area. These parameters are calculated as follows:

$$T_{\text{JMAX}} = T_{\text{MAX}} + (\theta_{\text{JA}} \times n \times PD_{\text{MAX}})$$
 (EQ. 1)

where:

 $T_{MAX} = Maximum ambient temperature$

 θ_{JA} = Thermal resistance of the package

n = Number of amplifiers in the package

 PD_{MAX} = Maximum power dissipation of each amplifier in the package

PD_{MAX} for each amplifier can be calculated as follows:

$$PD_{MAX} = (2 \times V_{S} \times I_{SMAX}) + \left[(V_{S} - V_{OUTMAX}) \times \frac{V_{OUTMAX}}{R_{L}} \right]$$
(EQ. 2)

where:

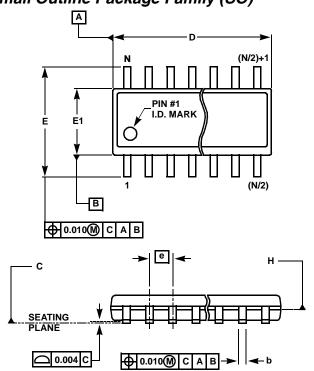
V_S = Supply voltage

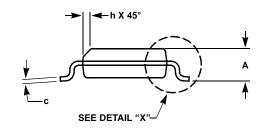
I_{SMAX} = Maximum supply current of 1A

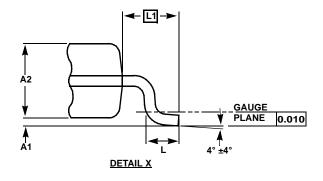
V_{OUTMAX} = Maximum output voltage (required)

R_L = Load resistance

Small Outline Package Family (SO)







MDP0027

SMALL OUTLINE PACKAGE FAMILY (SO)

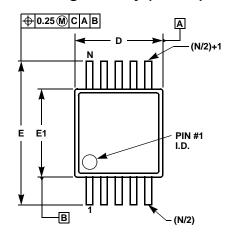
	INCHES								
SYMBOL	SO-8	SO-14	SO16 (0.150")	SO16 (0.300") (SOL-16)	SO20 (SOL-20)	SO24 (SOL-24)	SO28 (SOL-28)	TOLERANCE	NOTES
Α	0.068	0.068	0.068	0.104	0.104	0.104	0.104	MAX	-
A1	0.006	0.006	0.006	0.007	0.007	0.007	0.007	±0.003	-
A2	0.057	0.057	0.057	0.092	0.092	0.092	0.092	±0.002	-
b	0.017	0.017	0.017	0.017	0.017	0.017	0.017	±0.003	-
С	0.009	0.009	0.009	0.011	0.011	0.011	0.011	±0.001	-
D	0.193	0.341	0.390	0.406	0.504	0.606	0.704	±0.004	1, 3
Е	0.236	0.236	0.236	0.406	0.406	0.406	0.406	±0.008	-
E1	0.154	0.154	0.154	0.295	0.295	0.295	0.295	±0.004	2, 3
е	0.050	0.050	0.050	0.050	0.050	0.050	0.050	Basic	-
L	0.025	0.025	0.025	0.030	0.030	0.030	0.030	±0.009	-
L1	0.041	0.041	0.041	0.056	0.056	0.056	0.056	Basic	-
h	0.013	0.013	0.013	0.020	0.020	0.020	0.020	Reference	-
Ν	8	14	16	16	20	24	28	Reference	-

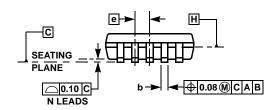
NOTES:

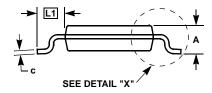
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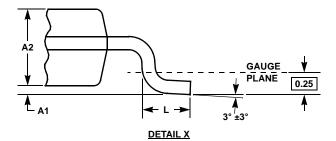
- 1. Plastic or metal protrusions of 0.006" maximum per side are not included.
- 2. Plastic interlead protrusions of 0.010" maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994

Mini SO Package Family (MSOP)









MDP0043 MINI SO PACKAGE FAMILY

	MILLIMETERS			
SYMBOL	MSOP8	MSOP10	TOLERANCE	NOTES
А	1.10	1.10	Max.	-
A1	0.10	0.10	±0.05	-
A2	0.86	0.86	±0.09	-
b	0.33	0.23	+0.07/-0.08	-
С	0.18	0.18	±0.05	-
D	3.00	3.00	±0.10	1, 3
E	4.90	4.90	±0.15	-
E1	3.00	3.00	±0.10	2, 3
е	0.65	0.50	Basic	-
L	0.55	0.55	±0.15	-
L1	0.95	0.95	Basic	-
N	8	10	Reference	-

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NOTES:

- Plastic or metal protrusions of 0.15mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25mm maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.

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